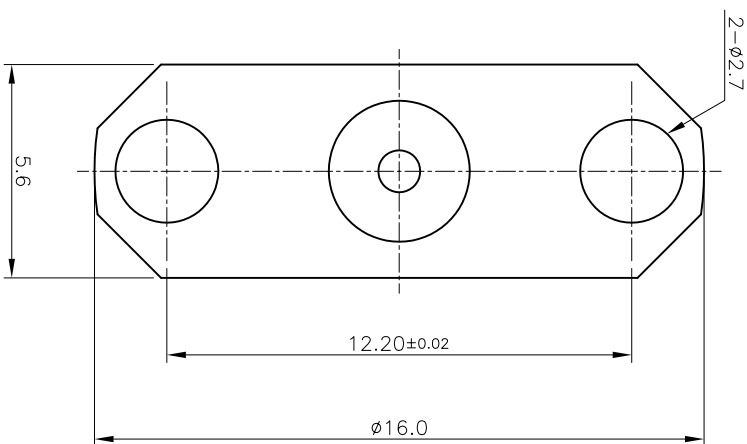
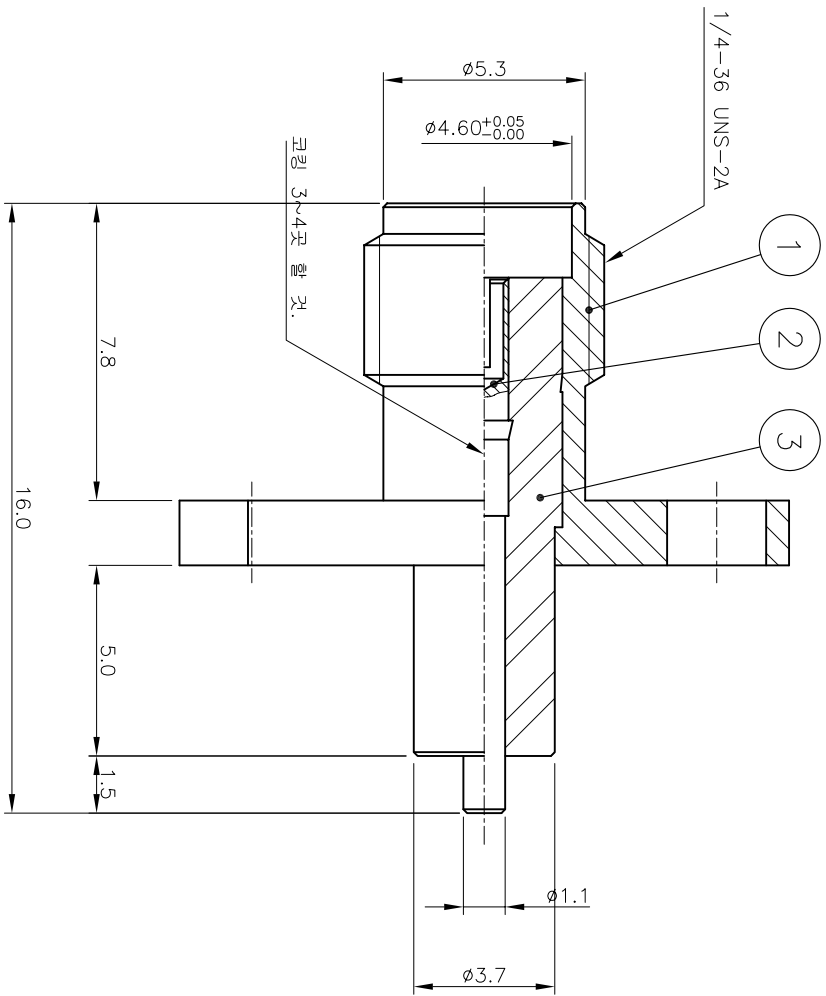


REVISION		
REV	DESCRIPTION	DATE
1R	최초 개정	2009. 02. 25.



3	INSULATOR	1	TEFLON		DIN01523-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT01922-5/1
1	BODY	1	MBSBD	Nickel Plate	DBD02405-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE		2009. 02. 25.					
	Angle	APPROVED BY		S.J.YOUN					
MATERIAL	±1°	CHECKED BY	I.C.KIM		TITLE SMA50 SOLDER END J-H2				
FINISH	-	DRAWN BY	E.H.KIM						
		SCALE	UNIT	 					
		5/1	mm						
		A4							
DWG NO.		CN02344-7/1		REVISION	1	R	SHEET	1 of 1	
					RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017				
KJ COMTECH CO.,LTD.									

SMA50 SOLDER END J-H2

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Fax : 82-32-347-8017

KJ COMTECH CO., LTD.